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May 2010

FDI8441_F085

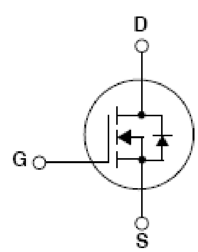
N-Channel PowerTrench® MOSFET
40V, 80A, 2.7mΩ

Features

- Typ $r_{DS(on)}$ = 2.2mΩ at V_{GS} = 10V, I_D = 80A
- Typ $Q_{g(10)}$ = 215nC at V_{GS} = 10V
- Low Miller Charge
- Low Q_{rr} Body Diode
- UIS Capability (Single Pulse and Repetitive Pulse)
- Qualified to AEC Q101
- RoHS Compliant

Applications

- Automotive Engine Control
- Powertrain Management
- Solenoid and Motor Drivers
- Electronic Steering
- Integrated Starter / Alternator
- Distributed Power Architectures and VRMs
- Primary Switch for 12V Systems



MOSFET Maximum Ratings T_C = 25°C unless otherwise noted

Symbol	Parameter	Ratings	Units
V_{DS}	Drain to Source Voltage	40	V
V_{GS}	Gate to Source Voltage	±20	V
I_D	Drain Current Continuous (T_C < 160°C, V_{GS} = 10V)	80	A
	Continuous (T_{amb} = 25°C, V_{GS} = 10V, with $R_{\theta JA}$ = 43°C/W)	26	
	Pulsed	See Figure 4	
E_{AS}	Single Pulse Avalanche Energy (Note 1)	947	mJ
P_D	Power dissipation	300	W
	Derate above 25°C	2	W/°C
T_J, T_{STG}	Operating and Storage Temperature	-55 to 175	°C

Thermal Characteristics

$R_{\theta JC}$	Thermal Resistance Junction to Case	0.5	°C/W
$R_{\theta JA}$	Thermal Resistance Junction to Ambient (Note 2)	62	°C/W
$R_{\theta JA}$	Thermal Resistance Junction to Ambient, 1in² copper pad area	43	°C/W

Package Marking and Ordering Information

Device Marking	Device	Package	Reel Size	Tape Width	Quantity
FDI8441	FDI8441_F085	TO-262AB	Tube	NA	50 units

Electrical Characteristics T_J = 25°C unless otherwise noted

Symbol	Parameter	Test Conditions	Min	Typ	Max	Units

Off Characteristics

Symbol	Parameter	Test Conditions	Min	Typ	Max	Units
B_{VDSS}	Drain to Source Breakdown Voltage	I_D = 250mA, V_{GS} = 0V	40	-	-	V
I_{DSS}	Zero Gate Voltage Drain Current	V_{DS} = 32V, V_{GS} = 0V	-	-	1	μA
		T_J = 150°C	-	-	250	
I_{GSS}	Gate to Source Leakage Current	V_{GS} = ±20V	-	-	±100	nA

On Characteristics

Symbol	Parameter	Test Conditions	Min	Typ	Max	Units
$V_{GS(th)}$	Gate to Source Threshold Voltage	V_{DS} = V_{GS}, I_D = 250μA	2	2.8	4	V
$r_{DS(on)}$	Drain to Source On Resistance	I_D = 80A, V_{GS} = 10V	-	2.2	2.7	mΩ
		I_D = 80A, V_{GS} = 10V, T_J = 175°C	-	3.8	4.7	

Dynamic Characteristics

Symbol	Parameter	Test Conditions	Min	Typ	Max	Units
C_{iss}	Input Capacitance	V_{DS} = 25V, V_{GS} = 0V, f = 1MHz	-	15000	-	pF
C_{oss}	Output Capacitance		-	1250	-	pF
C_{rss}	Reverse Transfer Capacitance		-	685	-	pF
R_G	Gate Resistance	V_{GS} = 0.5V, f = 1MHz	-	1.1	-	Ω
$Q_{g(TOT)}$	Total Gate Charge at 10V	V_{GS} = 0 to 10V; V_{DD} = 20V, I_D = 35A, I_g = 1mA	-	215	280	nC
$Q_{g(TH)}$	Threshold Gate Charge	V_{GS} = 0 to 2V	-	29	38	nC
Q_{gs}	Gate to Source Gate Charge		-	60	-	nC
Q_{gs2}	Gate Charge Threshold to Plateau		-	32	-	nC
Q_{gd}	Gate to Drain "Miller" Charge		-	49	-	nC

Electrical Characteristics T_J = 25°C unless otherwise noted

Symbol	Parameter	Test Conditions	Min	Typ	Max	Units

Switching Characteristics

Symbol	Parameter	Test Conditions	Min	Typ	Max	Units
$t_{(on)}$	Turn-On Time	V_{DD} = 20V, I_D = 35A V_{GS} = 10V, R_{GS} = 1.5Ω	-	-	77	ns
$t_{d(on)}$	Turn-On Delay Time		-	23	-	ns
t_r	Turn-On Rise Time		-	24	-	ns
$t_{d(off)}$	Turn-Off Delay Time		-	75	-	ns
t_f	Turn-Off Fall Time		-	17.9	-	ns
t_{off}	Turn-Off Time		-	-	147	ns

Drain-Source Diode Characteristics

Symbol	Parameter	Test Conditions	Min	Typ	Max	Units
V_{SD}	Source to Drain Diode Voltage	I_{SD} = 35A	-	0.8	1.25	V
		I_{SD} = 15A	-	0.8	1.0	V
t_{rr}	Reverse Recovery Time	I_F = 35A, di/dt = 100A/μs	-	52	68	ns
Q_{rr}	Reverse Recovery Charge	I_F = 35A, di/dt = 100A/μs	-	76	99	nC

Notes:
1: Starting T_J = 25^{o}C, L = 0.46mH, I_{AS} = 64A.
2: Pulse width = 100s.

This product has been designed to meet the extreme test conditions and environment demanded by the automotive industry. For a copy of the requirements, see AEC Q101 at: http://www.aecouncil.com/
All Fairchild Semiconductor products are manufactured, assembled and tested under ISO9000 and QS9000 quality systems certification.

Typical Characteristics

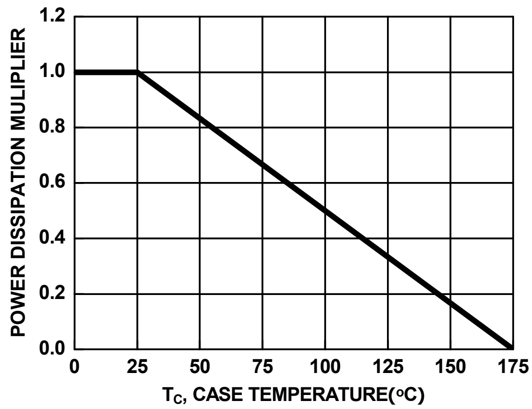


Figure 1. Normalized Power Dissipation vs Case Temperature

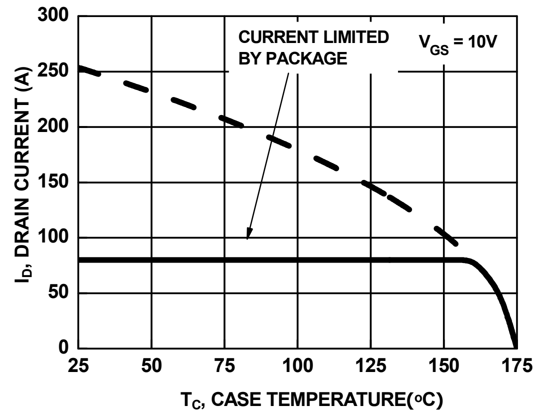


Figure 2. Maximum Continuous Drain Current vs Case Temperature

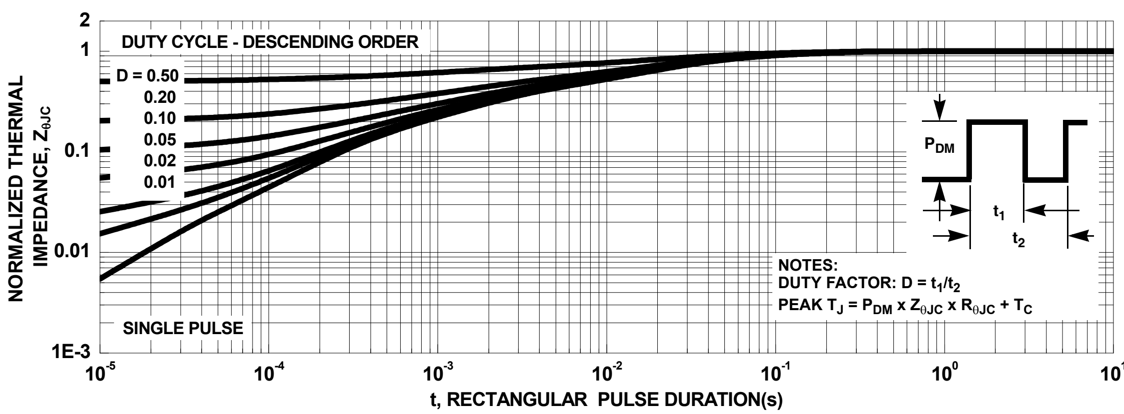


Figure 3. Normalized Maximum Transient Thermal Impedance

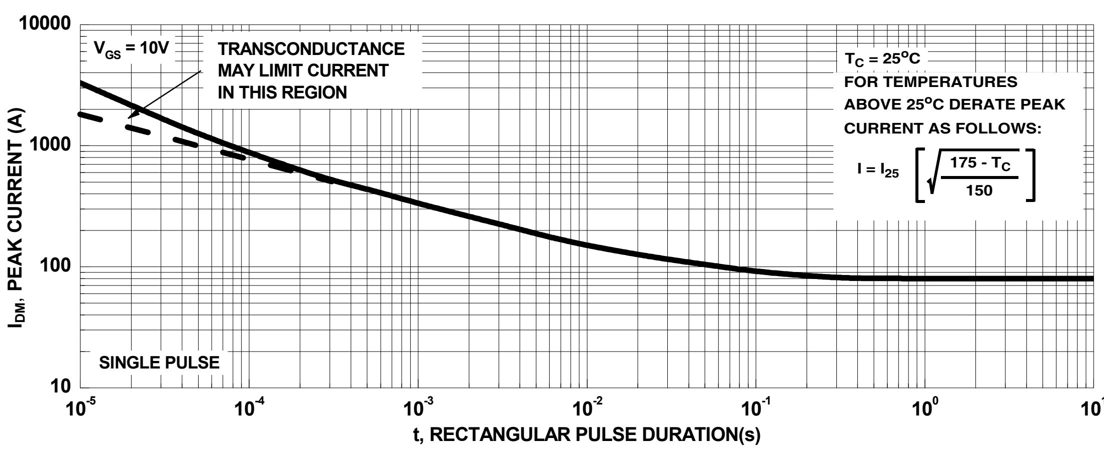


Figure 4. Peak Current Capability

Typical Characteristics

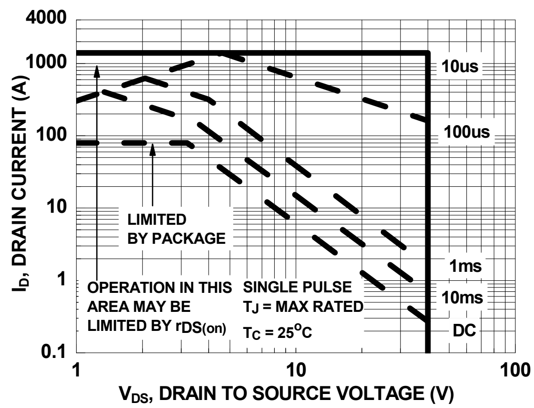
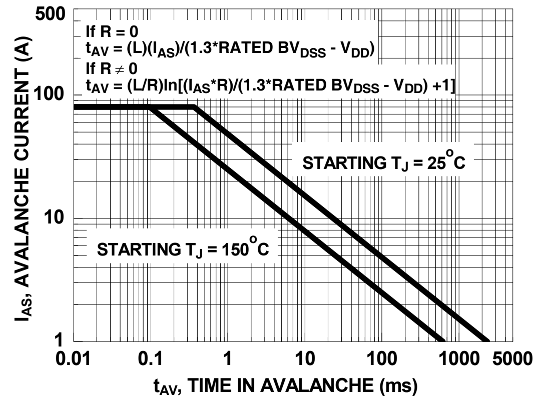


Figure 5. Forward Bias Safe Operating Area



NOTE: Refer to Fairchild Application Notes AN7514 and AN7515

Figure 6. Unclamped Inductive Switching Capability

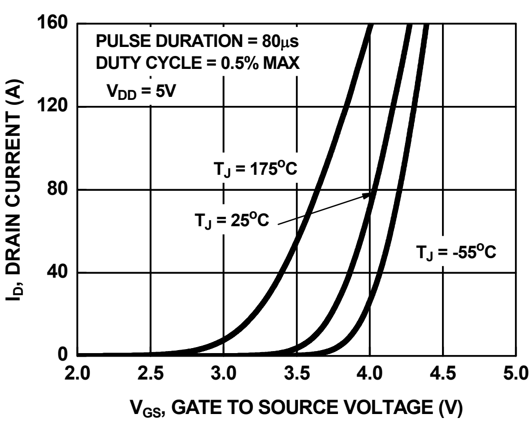


Figure 7. Transfer Characteristics

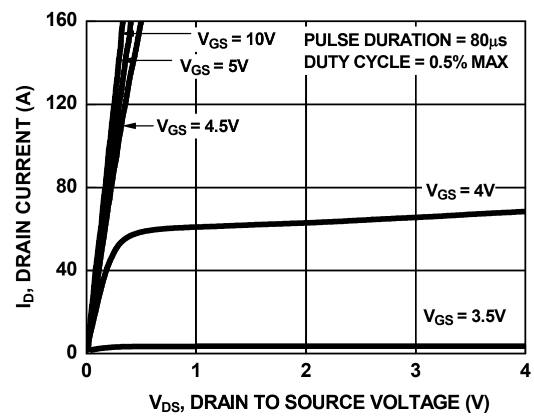


Figure 8. Saturation Characteristics

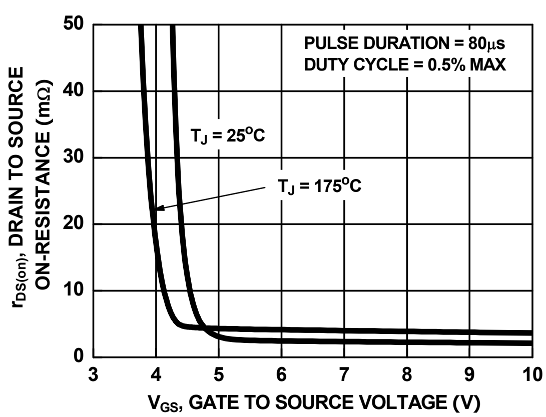


Figure 9. Drain to Source On-Resistance Variation vs Gate to Source Voltage

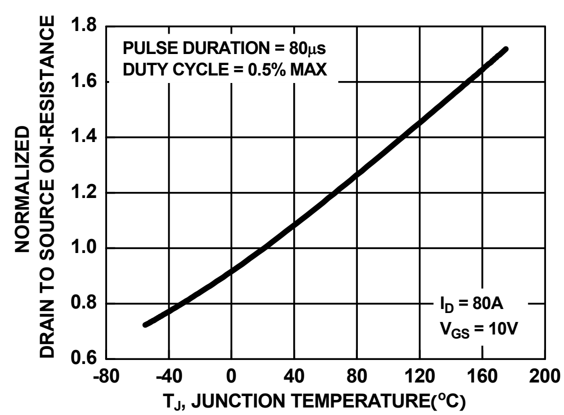


Figure 10. Normalized Drain to Source On Resistance vs Junction Temperature

Typical Characteristics

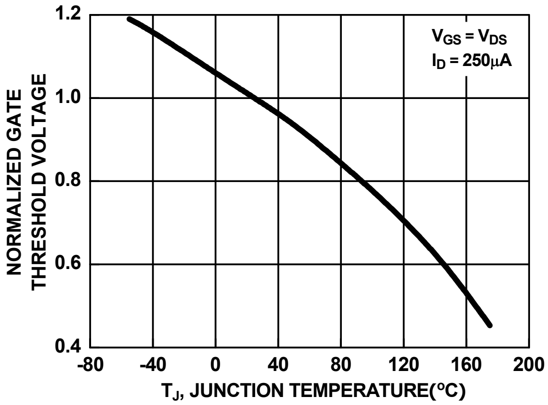


Figure 11. Normalized Gate Threshold Voltage vs Junction Temperature

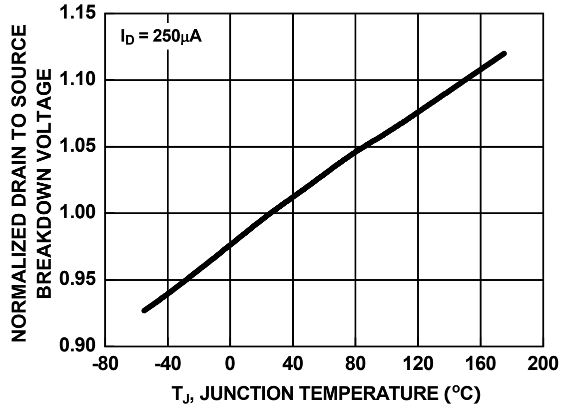


Figure 12. Normalized Drain to Source Breakdown Voltage vs Junction Temperature

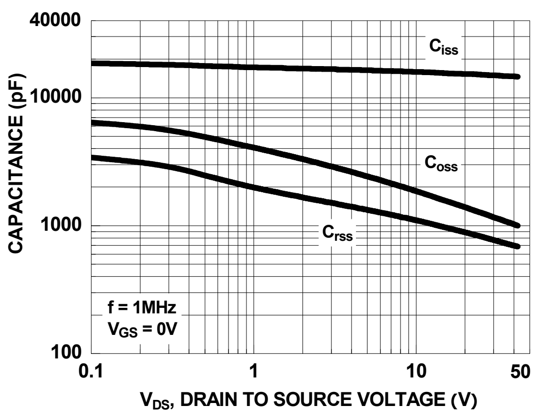


Figure 13. Capacitance vs Drain to Source Voltage

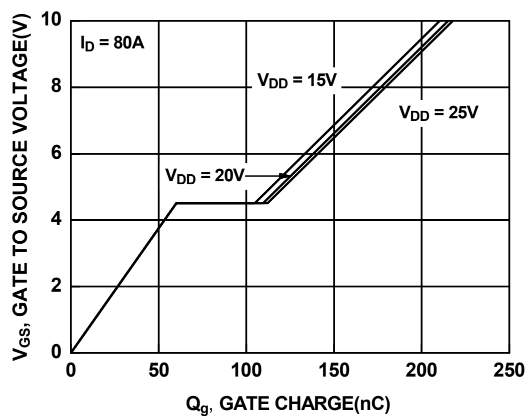


Figure 14. Gate Charge vs Gate to Source Voltage

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No Identification Needed	Full Production	Datasheet contains final specifications. Fairchild Semiconductor reserves the right to make changes at any time without notice to improve the design.
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Rev. I48

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